DISCONTINUED APRIL 2018. NO MORE SALES ORDERS FOR THIS PRODUCT. STANDARD 1 YEAR ELECTRONICS WARRANTY/ 8 YEAR TUBE WARRANTY ONLY.



DATA SHEET

Cs4000

Cesium Frequency



Key Features

- Multiple RF outputs
- CsIII technology
- AC & DC inputs
- Internal battery back-up
- CE compliant

Key Benefits

- Configurable 3U rack mount chassis allows for flexibility
- High stability, low noise RF and 1PPS reference makes it perfect for high precision timing and frequency applications
- Custom output signals available
- Standard 1 year electronics and 8-year tube warranty

The Microsemi® Cs4000 is a cesium frequency standard platform that provides exceptional performance in a configurable 3U rack mount chassis. The Cs4000 is designed for high precision timing and frequency applications requiring high stability, low noise RF and 1PPS reference signals. Microsemi's advanced Cesium III digital technology is the engine that drives this exceptional performance.

The Cs4000 is designed to provide standard and custom output signal formats simultaneously. Standard outputs include, 100 kHz, 1, 5, 10 MHz and 1 PPS. Custom output formats are supported via a configurable custom output area capable of supporting most custom signaling requirements.

The Cs4000 meets the challenges of laboratory standards, satcom terminals, mobile communications systems and a wide variety of test and measurement applications.

Cs4000

Specifications

ELECTRICAL SPECIFICATIONS

Frequency outputs

1 ea 100 kHz & 1 MHz Sine Frequency

Amplitude: 1 Vrms <-40 dBc Harmonic: <-80 dBc Non harmonic: Connector: BNC Load impedance: 50 O Location: rear panel

Frequency: 2 ea 5 & 10 MHz Sine

Amplitude: 1 Vrms <-40 dBc Harmonic: Non harmonic <-80 dBc Connector: Type N Load impedance: 50 Ω rear panel Location:

• Timing outputs

Three 1 PPS Format: Amplitude: >3.0 V into 50 Ω Pulse width: 20 µs positive pulse

Rise time: <5 ns Jitter: <1 ns rms Connector: BNC Load impedance: 50 Ω

Location: rear panel (2) front panel (1)

• Timing inputs Two 1 PPS Sync input: Connector: **BNC** Load impedance: 50.0

rear panel (1) Location: front panel (1)

REMOTE SYSTEM INTERFACE, CONTROL AND ALARM

• RS-232-C (DTE Configuration) Complete remote control and interrogation of all instrument functions and parameters

Connector: 9-Pin male rectangular D subminiature type

Location: Front panel [1] Rear panel [1]

• Alarm (TTL) High, Normal Low. Alarm

Circuit is TTL open collector with internal

pull-up resistor.

Circuit can sync up to 10mA

BNC Connector: Location: Rear panel

PERFORMANCE SPECIFICATIONS

• Performance

Accuracy ±1.0E-12 Warm-up time: 30 Min (typical) Reproducibility: ±2.0E-13 Settability

Range: ±1.0E-9 Resolution: 1.0E-15

Stability

AvgTime (s) Allan Deviation ≤1.2E-11 1 10 ≤8.5E-12 ≤2.7E-12 100 1,000 ≤8.5E-13 10,000 ≤2.7E-13 100,000 ≤8.5E-14 Floor ≤5.0E-14

• SSB Phase noise

Offset (Hz) 5 MHz Output 1 <-95 dBc <-130 dBc 10 100 <-145dBc 1,000 <-155 dBc 10,000 <-155 dBc 100,000 <-160 dBc

ENVIRONMENTAL & PHYSICAL SPECIFICATIONS

• General environment

Operating

Temperature: 0°C to 50°C

Humidity: 95% up to 50°C (non-condensing)

Non-operating (transport)

Temperature

(storage): -30°C to 70°C Temperature (short term): -40°C to 75°C

Magnetic field: 0 to 2 gauss 0 to 50,000' Altitude (operating):

AC Power requirements

Operating voltage (±10%): 100 to 240 VAC 47 to 63 Hz

Frequency: Power

Operating: <65 W <80 W Warm-up:

• DC Power requirements

36 - 75 VDC

60 W Operating: 70 W Warm Up:

22 - 36 VDC* *24 VDC Power Supply Option • Dimensions: 17.22" W x 5.22" H x 20.63" D (43.73 cm x 13.25 cm x 52.40 cm)

• Internal standby battery

45 minutes @ 25°C from full charge Capacity:

(without front panel display) 20 minutes @ 25°C from full charge

(with front panel display)

Charge time: 16 hours maximum from fully discharged state

Charge source: AC or DC • Weight: 45 lbs. (20.4 Kg) • MTBF: >145,000 hrs.

ORDERING INFORMATION Part No. • 48 VDC 14645-105 • 24 VDC 14645-106



Rear view of Cs4000



Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor solutions for aerospace, defense and security; enterprise and communications; and industrial and alternative energy markets. Products include high-performance, high-reliability analog and RF devices, mixed signals and RF integrated circuits, customizable SoCs, FPGAs, and complete subsystems. Microsemi is headquartered in Aliso Vieio. Calif. Learn more at

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